## IN THE CLAIMS:

	1. Cancelled.		
	2. Cancelled.		
. 3	3. Cancelled.		
4	. Cancelled.		
5.	Cancelled.		•
6.	Cancelled.		
7.	Cancelled.		
8.	(THRICE AMENDEI	D) The A printed circuit board unit comprising	; <b>.</b>
a printed circuit board;			
an electronic component;  a solder bump interposed between the printed circuit board and the electronic component so			
as to fix the electronic component to the printed circuit board; and			

an interposer disposed between the printed circuit board and the electronic component so as to define a through hole for containing the solder bump wherein

at least an inner surface of the through hole is covered with a coating wet to a melted state of the solder bump, said coating being spaced from an outer periphery of the solder bump.

- 9. Cancelled.
- 10. Withdrawn.
- 11. Withdrawn.
- 12. Withdrawn.
- 13. Withdrawn.
- 14. Withdrawn.
- 15. Withdrawn.
- 16. Cancelled.

17. (NEW) The printed circuit board unit according to claim 8, wherein said interposer is spaced from at least one of the printed circuit board and the electronic component